FORM PTO-1594 (Modified) (Rev. 6-93)	06-21-	1999	Т	Docket No.:
OMB No. 0651-0011 (exp.4/94) Copyright 1994-97 LegalStar 6-16-99 TM05/REV03			1	8062-1a
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To the Honorable Commissioner of Paten	UTUY.	Lease record	rne attached original	documents or copy thereof.
1. Name of conveying party(ies): Ribbon Technology Corporation 巨色巨型型型型型型型型型型型型型型型型型型型型型型型型型型型型型型型型型型型				
Ribbon Technology Corporation		Name: <u>B</u>	arclays Bank PLC	
l li	N 16	Internal Ad	ddress: <u>Corporate</u>	Banking Center
	ssociation	Street Add	ress: PO Box 564,	14 Park Row
☐ General Partnership ☐ L ☑ Corporation-State Ohio	imited Partnership	City: Noti	tingham, NG8 6PE	_ State: <u>Eng</u> ZIP:
Other				
Additional names(s) of conveying party(ies)	☐ Yes 🔀 No			
Nature of conveyance:				
·	/lerger		ation-State <u>ENGL</u>	
_	Change of Name			
Other		_	not domiciled in the Unit	ted States, a domestic
Execution Date: <u>June 1, 1999</u>		designation is (Designations	s s must be a separate doc	☐ Yes N cument from
			me(s) & address(es)	
	Additional numbers	☐ Yes		
5. Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of applications and registrations involved:		
Name: <u>James R. Eley Reg. No. 36,790</u>		7. Total fee (37 CFR 3.41):\$ \$40.00		
Internal Address:KEGLER, BROWN, HILL & RITTER, LPA			sed	
		☐ Author	rized to be charged t	o deposit account
Street Address: 65 E. State St., Suite 1800		8. Deposit account number:		
		05-0960		
City: <u>Columbus</u> State: <u>Columbus</u>	OH ZIP: 43215			
6/21/1999 HTHAI1 00000019 1125297	DO NOT U	ISE THIS SPACE		
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9. Statement and signature.				
To the best of my knowledge and belief, t	<u> </u>		·	ached copy is a true copy
of the original document.	Daniela	mure	110-	6/11/1000
James R. Eley Name of Person Signing	_ (Juni	Signature	-	
Total number of pages including cover sheet, attachments, and				
TRADEMARK				

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MEMORANDUM OF SECURITY AGREEMENT AND FINANCING STATEMENT

This Memorandum of Security Agreement and Financing Statement acknowledges that a Security Agreement and Financing Statement (the "Agreement") was entered into on this date between Ribbon Technology Corporation, an Ohio corporation having its mailing address at 825 Taylor Station Road, Gahanna, OH 43230, (the "Debtor") and Barclays Bank PLC, a public limited company registered in England and Wales, having its mailing address at Corporate Banking Centre, PO Box 564, 14 Park Row, Nottingham NG8 6PE, England (the "Secured Party"), granting to the Secured Party a security interest in the following patent and trademark properties of the Debtor in accordance with the specific terms of that Agreement:

- Each of the U.S. Letters Patent and applications for U.S. Letters Patent as shown in Exhibit A, attached; and
- U.S. Trademark Registration No. 1,125,297 for the mark, "RIBTEC", issued September 25, 1979.

Dated: June 1, 1999

Debtor:

RIBBON TECHNOLOGY CORPORATION

an Ohio corporation

By:

Brian Irvine, Treasurer

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EXHIBIT A

U.S. PATENTS AND PENDING APPLICATIONS

1. TITLE: Metal Fiber Preforms and Method for Making the Same

U.S. Patent No. 5,571,628 Date: November 5, 1996 Inventor: Lloyd E. Hackman

Assignee: Ribbon Technology Corporation

Application No. 96,518 Filed: July 23, 1993

2. TITLE: Strip Forming Apparatus for Rapid Solidification

U.S. Patent No. 5,345,993 Date: September 13, 1994 Inventor: Lloyd E. Hackman

Assignee: Ribbon Technology Corporation

Application No. 116,513 Filed: September 7, 1993

3. TITLE: Method for Manufacturing a Reinforced Cementitious Structural Member

U.S. Patent No. 5,308,572

Date: May 3, 1994

Inventor: Lloyd E. Hackman

Assignee: Ribbon Technology Corporation

Application No. 977,815 November 17, 1992

4. TITLE: Melt Overflow Control for Constant Linear Density Fiber Mat and Strip

U.S. Patent No. 5,213,151

Date: May 25, 1993

Inventor: Lloyd E. Hackman

Assignee: Ribbon Technology Corporation

Application No. 932,576 Filed: August 20, 1992

5. TITLE: Apparatus for Flow Control of Molten Material by Force Detection

U.S. Patent No. 4,977,951 Date: December 18, 1990 Inventor: Lloyd E. Hackman

Assignee: Ribbon Technology Corporation

Application No. 462,794 Filed: January 10, 1990

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6. TITLE: Melt Overflow System for Producing Filamentary and Film Products Directly from Molten Materials

U.S. Patent No. 4,930,565

Date: June 5, 1990 (portion subsequent to March 21, 2006, disclaimed)

Inventors: Lloyd E. Hackman, James Dickson, David L. Dunlap, and Mark E. Handshey

Assignee: Ribbon Technology Corporation

Application No. 278,016 Filed: November 30, 1988

Japan Letters Patent No. 2009042 (Method and Apparatus for Producing Ribbon,

Filaments, Fiber or Film)
Date: November 11, 1996

Ribbon Technology Corporation

7. TITLE: Rotatable Crucible for Rapid Solidification Process

U.S. Patent No. 4,907,641 Date: March 13, 1990 Inventor: Thomas Gaspar

Assignee: Ribbon Technology Corporation

Application No. 290,274 Filed: December 27, 1988

8. TITLE: Melt Overflow System for Producing Filamentary and Film Products Directly from Molten Materials

U.S. Patent No. RE 33,327 Date: September 11, 1990

Inventor: Lloyd E. Hackman, James Dickson, David L. Dunlap, and Mark E. Handshey

Assignee: Ribbon Technology Corporation

Application No. 89,544 Filed: August 26, 1987

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RECORDED: 06/16/1999